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Serial Number: 09/029,608

Filed: May 15, 1998

For: METHOD AND MOLD FOR MANUFACTURING SEMICONDUCTOR DEVICE,
SEMICONDUCTOR DEVICE, AND METHOD FOR MOUNTING THE DEVICE

Assistant Commissioner for Patents
Washington, D.C. 20231

February 26, 1999

Transmitted herewith is an Amendment in the above-identified application.

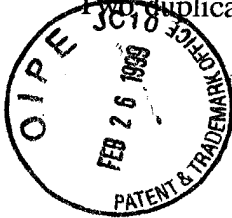
Small Entity status of this application under 37 CFR 1.9 and 1.27 has been established by a verified statement previously submitted.

— A verified statement to establish Small Entity status under 37 CFR 1.9 and 1.27 is enclosed.

The fee has been calculated as shown below:

	CLAIMS AS AMENDED						
	Claims Remaining After Amendment	Highest Number Previously Paid For		Present Extra	Small Entity	Large Entity	Additional Fee
Total Claims	105-20	125	=	0	X \$11	X \$22	\$0.00
Independent Claims	26-3	16	=	10	X \$41	X \$82	\$820.00
## First Presentation of Multiple Dependent Claims					\$135	270	
TOTAL FEES ENCLOSED:							\$820.00

XX Enclosed please find our check in the amount of \$820.00 for the additional claims fee in connection with this amendment. The Commissioner is hereby authorized to charge payment for any additional fees associated with this communication or credit any overpayment to Deposit Account No. 01-2340. Two duplicates of this sheet are attached.



Respectfully submitted,

ARMSTRONG, WESTERMAN, HATTORI,
MCLELAND & NAUGHTON

A handwritten signature in dark ink, appearing to read "Stephen G. Adrian".

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

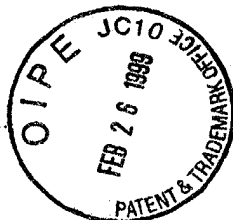
Norio FUKASAWA et al.

Serial No.: 09/029,608

Filed: May 15, 1998

Group Art Unit: 2812

For: METHOD AND MOLD FOR MANUFACTURING SEMICONDUCTOR DEVICE,
SEMICONDUCTOR DEVICE, AND METHOD FOR MOUNTING THE DEVICE



SUPPLEMENTAL PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231
Sir:

February 26, 1999

Further to the Preliminary Amendment filed May 15, 1998, please amend the above-captioned patent application as follows:

IN THE CLAIMS:

- Claim 1, line 2, delete "characterized by";
line 5, after "formed", insert --to a mold--.
- Claim 2, line 3, change "characterized in that" to --wherein--.
- Claim 3, line 2, delete "or 2";
line 3, change "characterized in that" to --wherein--.

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TECHNICAL STAFF